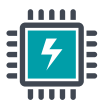


## KEY FEATURES



### Qualcomm

Qualcomm QCS6490 high-level platform



### LPDDR5x

LPDDR5x on board memory up to 8G



### AMR

Target on AMR, box PC application



### Ruggedized

Thin client concept and ruggedized design



### 2 M.2 Expansions

1 M.2 E key 2230, 1 M.2 B key 3052

## SPECIFICATION

SYSTEM	Processor	QCS6490 Qualcomm® Kryo™ 670, 8 cores, up to 2.7 GHz, 12 TOPS (INT8) QCS5430 (FP1) Qualcomm® Kryo™ 670, 6 cores, up to 2.1 GHz, 3.5 TOPS (INT8)
	Memory	LPDDR5x, 4/8GB
GRAPHICS	Controller	Qualcomm® Adreno™ 643L GPU
	Feature	OpenGL ES 3.2
	Display	1 x HDMI Type A, w/o audio. 1080P support on Linux.
	Single Display	HDMI
STORAGE	UFS	Support UFS 3.1, default 128GB
EXPENSION	Interface	1 x M.2 B key 3052 (USB 3.1/ Opt. USB 2.0) reference RM502Q-AE Quectel *Optional USB 2.0 signal with UBJ4
		1 x Nano SIM slot
		1 x M.2 E key 2230 (PCIe x1) reference ENL-Q6856M2 Wifi module
AUDIO	Audio Codec	Audio codec WCD9385
ETHERNET	Controller	AX88179A USB3 to GbE controller
REAR I/O	Ethernet	1 x GbE (RJ-45)
	USB	2 x USB 3.1 Gen1 Type A
	Display	1 x HDMI 1.4
	Audio	1 x Line out/Mic in audio jack
	Debug	1 x Micro USB debug UART
INTERNAL I/O	Serial	1 x RS-232 (COM1, 1x5P/1.00mm)
	USB	3 x USB 2.0 (UBJ1/2/4, 1x4P/1.25mm), UBJ4 could option to M.2 B key 1 x USB Type C (Download only)
	DIO	1 x 8-bit DIO
	CANBus	1 x CAN FD
	SD	1 x uSD3.0 card
	Camera	2 x MIPI-CSI2 for 4-lanes camera, reference to IMX577
	Other I/O	1 x Ext. IO (1*12P/1.25mm), 1 x Power LED, 1 x System LED, 1 x Front Panel 1 x Fan connector (upon request)
POWER	Type	5VDC
	Connector	2 pin Power Jack
	Consumption	<b>Typical:</b> QCS6490: 5V @ 0.6A (3.0Watt) <b>Max.:</b> QCS6490: 5V @ 1.45A (7.25Watt)
	RTC Battery	CR2032 Coin Cell
OS SUPPORT	Linux	<b>Default:</b> Yocto (Linux Kernel 6.6.x) <b>Upon request:</b> Ubuntu 20.04 (Linux Kernel 5.4.x)
ENVIRONMENT	Temperature	<b>Operating:</b> 0°C~60°C, -25°C~75°C <b>Storage:</b> -40°C~85°C
	Humidity	<b>Operating:</b> 5%~90% RH <b>Storage:</b> 5%~90% RH
MECHANISM	Dimensions	2.5" Pico-ITX Form Factor 100mm (3.94") x 72mm (2.83")
	Height	<b>PCB:</b> 1 mm <b>Top Side:</b> 16.44 mm <b>Bottom Side:</b> 3.45 mm
STANDARDS AND CERTIFICATIONS	Certifications	CE, FCC, RoHS, UKCA

## ORDERING INFORMATION

Model Name	P/N	Processor	Memory	UFS	Display	GbE	USB 3.1 Gen1	USB 2.0	RS-232	Power	Thermal	Temp.
QCS051-BCC-4890	770-QCS0511-000G	Qualcomm® QCS6490	LPDDR5x 4GB									0 to 60°C
QCS051-ECC-8890	770-QCS0511-100G	Qualcomm® QCS6490	LPDDR5x 8GB	128 GB	HDMI	1	2	3	1	5VDC	Fanless	-25 to 75°C
QCS051-BCC-4830	770-QCS0511-300G	Qualcomm® QCS5430	LPDDR5x 4GB									0 to 60°C

## PACKING LIST

• 1 QCS051 board	
• Heat spreader (Height: 7mm)	A71-808357-000G

## OPTIONAL ITEMS

• Heat sink for 0 to 60°C/-25 to 75°C (Height: 17.1mm)	A71-008191-010G
• USB 2.0 port cable (Length: 100mm)	A81-001188-018G
• COM port cable (Length: 200mm)	A81-015121-018G
• CAN Bus cable (Length: 150mm)	A81-015122-018G
• 2 pole to DC Jack power cable (Length: 150mm)	A81-004381-018G
• Front panel cable (Length: 150mm)	A81-006104-018G
• Power adapter (30W, 5V, DC Jack)	671-103002-000G